



DRTR5V0U4SL

4 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

Features

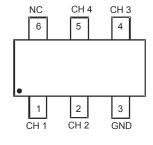
- IEC 61000-4-2 (ESD): Air ±30kV, Contact ±25kV
- 4 Channels of ESD Protection
- Low Channel Input Capacitance of 0.8pF Typical
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

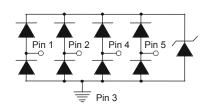
Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.006 grams (approximate)









Top View

Device Pinout

Device Schematic

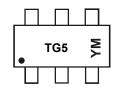
Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DRTR5V0U4SL-7	Standard	TG5	7	8	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



TG5 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013)M = Month (ex: 9 = September)

Date Code Key

Year	2013	3	2014		2015	20	16	2017		2018	2	2019
Code	Α		В		С)	Е		F		G
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I _{PP}	5	Α	8/20 μs, Per Figure 2
ESD Protection – Contact Discharge	V _{ESD_Contact}	±25	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	$V_{ESD\ Air}$	±30	kV	Standard IEC 61000-4-2

Thermal Characteristics

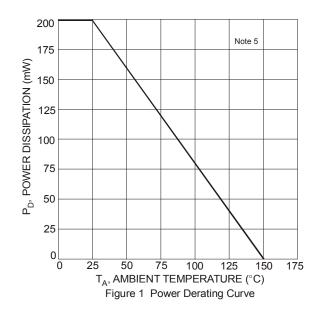
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

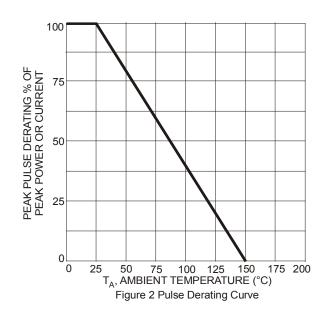
Electrical Characteristics (@T_A = +25°C, unless otherwise specified)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}	_	_	5.5	V	_
Channel Leakage Current (Note 6, 7)	I _R	_	1	10	nA	V _R = 2.5V
Reverse breakdown voltage	V_{BR}	7.0	_	9.5	V	I _R = 1mA, from CH to GND
Clamping Voltage, Positive Transients		_	10.5	_	V	$I_{PP} = 1A$, $t_p = 8/20 \mu s$
Clamping voltage, Positive Transients	V _{CL}	_	12.5	_	V	$I_{PP} = 3A$, $t_p = 8/20 \mu s$
Forward Voltage	V _F	_	0.8	_	V	I _F = 1mA
Dynamic Resistance	В	_	0.8	_	()	I_{TLP} = 10A to 20A, t_p = 100ns, I/O to GND
Dynamic Resistance	R _{DYN}	_	0.6	_		I_{TLP} = 10A to 20A, t_p = 100ns, GND to I/O
I/O to GND Capacitance	C _(I/O-GND)	_	0.8	1.2	pF	$V_{(I/O-GND)} = 2.5V, f = 1MHz$

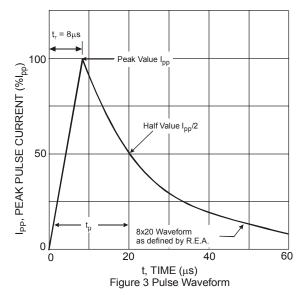
Notes:

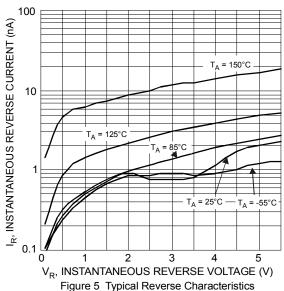
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Measured from pin 1, 2, 4, or 5 to GND.
- 8. For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destools/appnote_dnote.html.

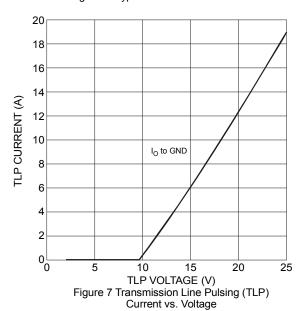


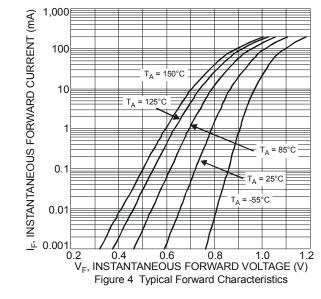












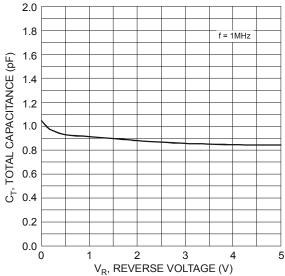
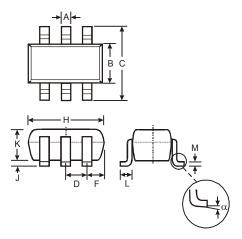


Figure 6 Typical Total Capacitance vs. Reverse Voltage



Package Outline Dimensions

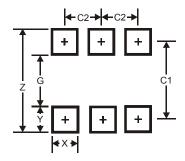
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SOT363						
Dim	Min	Max	Тур				
Α	0.10	0.30	0.25				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D	0.65 Typ						
F	0.40	0.45	0.425				
Н	1.80	2.20	2.15				
J	0	0.10	0.05				
K	0.90	1.00	1.00				
L	0.25	0.40	0.30				
M	0.10	0.22	0.11				
α	0°	8°	-				
All	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.5
G	1.3
X	0.42
Υ	0.6
C1	1.9
C2	0.65



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